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10/084787  
02/25/02

PATENT NUMBER and  
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10084787	FILING DATE 02/25/2002	CLASS 257	SUBCLASS 778	GAU 2811	EXAMINER Williams
<b>**APPLICANTS:</b> Pendse Rajendra; Tam Samuel;					
<b>**CONTINUING DATA VERIFIED:</b> THIS APPLN CLAIMS BENEFIT OF 60/272,236 02/27/2001					
<b>** FOREIGN APPLICATIONS VERIFIED:</b>					
PG-PUB DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO	
Verified and Acknowledged Examiners's initials				CPAC 1010-2 US	
TITLE : Super-thin high speed flip chip package					

U.S. DEPT. OF COMM / PAT. & TM-PTO-436L (Rev. 12-94)

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<b>NOTICE OF ALLOWANCE MAILED</b>		<b>Assistant Examiner</b>	<b>CLAIMS ALLOWED</b>	
			Total Claims	Print Claim for O.G.
<b>ISSUE FEE</b>		<b>Primary Examiner</b>	<b>DRAWING</b>	
Amount Due	Date Paid		Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>		<b>PREPARED FOR ISSUE</b>	<b>Application Examiner</b>	
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